

# **NPT Trench IGBT**

## 1200 V, 25 A

## FGA25N120ANTDTU

## Description

Using **onsemi**'s proprietary trench design and advanced NPT Technology, the 1200 V NPT IGBT offers superior conduction and switching performances, high avalanche ruggedness and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating, microwave oven.

#### **Features**

- NPT Trench Technology, Positive Temperature Coefficient
- Low Saturation Voltage: V<sub>CE(sat)</sub>, typ = 2.0 V
  @ I<sub>C</sub> = 25 A and T<sub>C</sub> = 25 °C
- Low Switching Loss:  $E_{CE \text{ off, typ}} = 0.96 \text{ mJ}$ @  $I_C = 25 \text{ A}$  and  $T_C = 25 ^{\circ}\text{C}$
- Extremely Enhanced Avalanche Capability
- This Device is Pb-Free Halide, Free and RoHS Compliant



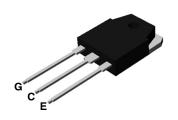
• Induction Heating, Microwave Oven

## **ABSOLUTE MAXIMUM RATINGS**

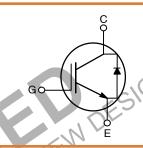
Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	±20	
I <sub>C</sub>	Collector Current (@T <sub>C</sub> = 25 °C)	50	Α
	Collector Current (@T <sub>C</sub> = 100 °C)	25	
I <sub>CM</sub>	Pulsed Collector Current (Note 1)	90	Α
IF	Diode Continuous Forward Current (@ $T_C = 25$ °C)	50	Α
<	Diode Continuous Forward Current (@T <sub>C</sub> = 100 °C)	25	Α
I <sub>FM</sub>	Diode Maximum Forward Current	150	Α
P <sub>D</sub>	Maximum Power Dissipation (@ $T_C = 25$ °C)	312	V
	Maximum Power Dissipation (@T <sub>C</sub> = 100 °C)		V
T <sub>J</sub> Operating Temperature Range		-55 to +150	°C
T <sub>STG</sub>	T <sub>STG</sub> Storage Temperature Range		°C
TL	T <sub>L</sub> Maximum Lead Temp for Soldering Purpose, 1/8" from Case for 5 s		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive Rating: Pulse-width limited by maximum junction temperature.



TO-3P-3 CASE 340BZ



MARKING DIAGRAM

FGA25 N120 AYWWZZ

FGA25N120

= Specific Device Code

A

= Assembly Location

YWW ZZ = Date Code (Year and Week)

= Assembly Lot Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R <sub>θJC</sub> (IGBT)	Thermal Resistance, Junction to Case	0.4	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction to Case	2.0	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	40	°C/W

## **ORDERING INFORMATION**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA25N120ANTDTU-F109	FGA25N120ANTD	TO-3PN	Tube	N/A	N/A	30

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

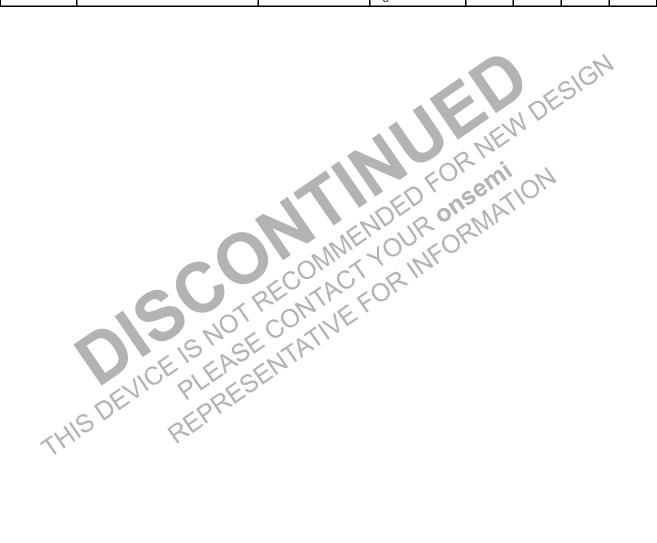
## **ELECTRICAL CHARACTERISTICS OF THE IGBT** ( $T_C = 25$ °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Character	ristics				5	
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> =V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	1 Dr	3	mA
I <sub>GES</sub>	G-E Leakage Current	V <sub>GE</sub> =V <sub>GES</sub> , V <sub>CE</sub> = 0 V		14 -	±250	nA
On Character	ristics		' Mr			
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 25 \text{ mA}, V_{CE} = V_{GE}$	3.5	5.5	7.5	٧
V <sub>CE(Sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V	67	2.0	-	V
		$I_C = 25 \text{ A}, V_{GE} = 15 \text{ V}, T_C = 125 ^{\circ}\text{C}$	1-V	2.15	-	V
		I <sub>C</sub> = 50 A, V <sub>GE</sub> = 15 V	$5/L_{L_L}$	2.65	_	V
Dynamic Cha	racteristics	Wr. 100.50				
C <sub>ies</sub>	Input Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	-	3700	-	pF
C <sub>oes</sub>	Output Capacitance	COLON OR	-	130	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	MY FO.	-	80	-	pF
Switching Ch	aracteristics	-01.11/2				
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC} = 600 \text{ V, } I_{C} = 25 \text{ A,}$	-	50		ns
t <sub>r</sub>	Rise Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 125 ^{\circ}C$	_	60		ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	190		ns
t <sub>f</sub>	Fall Time		_	100		ns
E <sub>on</sub>	Turn-On Switching Loss		_	4.1		mj
E <sub>off</sub>	Turn-Off Switching Loss		-	0.96		mj
E <sub>ts</sub>	Total Switching Loss		-	5.06		mj
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 25 A,	-	50		ns
t <sub>r</sub>	Rise Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 125 ^{\circ}C$	-	60		ns
t <sub>d(off)</sub>	Turn-Off Fall Time	, ,	-	200		ns
t <sub>f</sub>	Fall Time		-	154		ns
E <sub>on</sub>	Turn-On Switching Loss		-	4.3		mj
E <sub>off</sub>	Turn-Off Switching Loss		_	1.5		mj
E <sub>ts</sub>	Total Switching Loss		-	5.8		mj
$Q_g$	Total Gate Charge	V <sub>CE</sub> = 600 V, I <sub>C</sub> = 25 A, V <sub>GE</sub> = 15 V	-	200		nC
Q <sub>ge</sub>	Gate-Emitter Charge		-	15		nC
Q <sub>gc</sub>	Gate-Collector Charge		-	100		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **ELECTRICAL CHARACTERISTICS OF DIODE** (T<sub>C</sub> = 25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 25 A	T <sub>C</sub> = 25 °C	-	2.0	3.0	V
			T <sub>C</sub> = 125 °C	_	2.1	_	
t <sub>rr</sub>	Diode Reverse Recovery Time	$dI_E/dt = 100 A/us$	T <sub>C</sub> = 25 °C	_	235	350	ns
			T <sub>C</sub> = 125 °C	_	300	_	
I <sub>rr</sub>		T <sub>C</sub> = 25 °C	_	27	40	Α	
	Current	_	T <sub>C</sub> = 125 °C	_	31	_	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25 °C	_	3130	4700	nC
			T <sub>C</sub> = 125 °C	_	4650	-	



## TYPICAL PERFORMANCE CHARACTERISTICS

Collector Emitter Voltage (V)

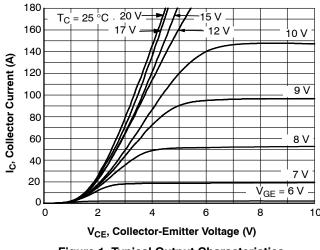


Figure 1. Typical Output Characteristics

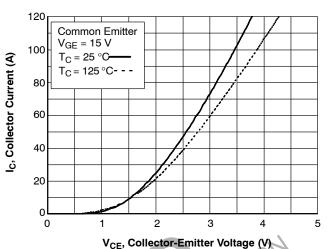


Figure 2. Typical Saturation Voltage Characteristics

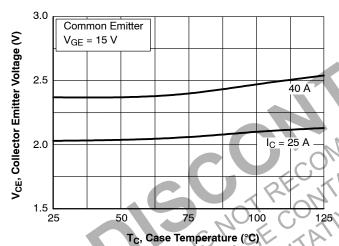
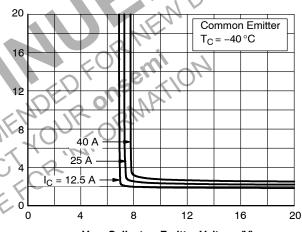


Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level



 $V_{GE}$ , Collector-Emitter Voltage (V) Figure 4.  $V_{GE}$  vs Saturation Voltage

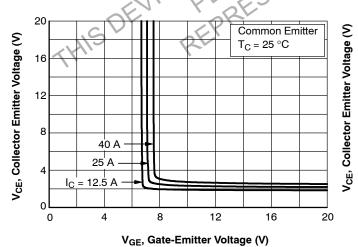


Figure 5. V<sub>GE</sub> vs. Saturation Voltage

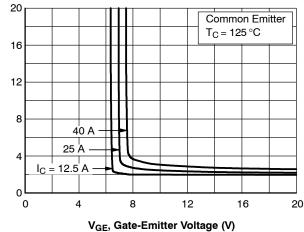
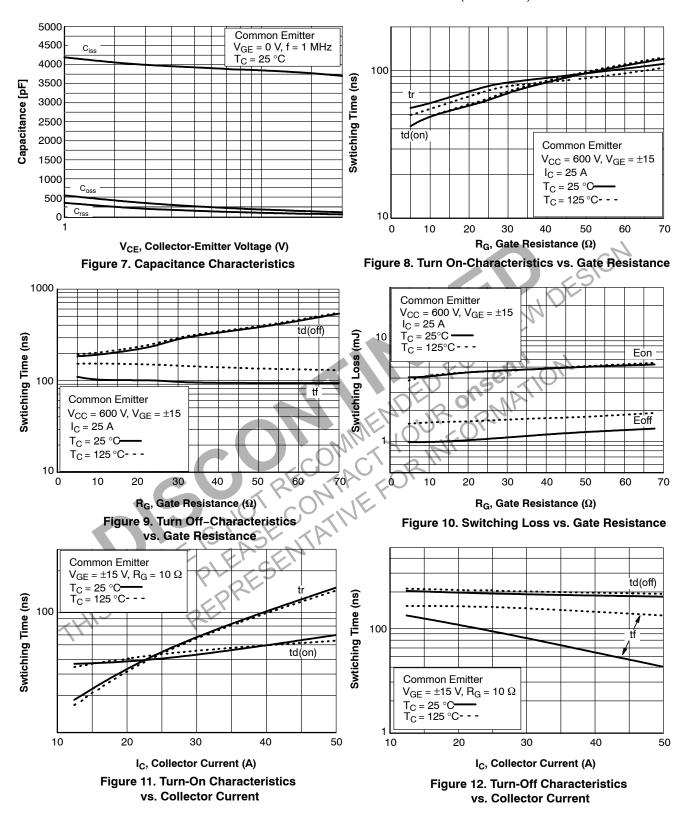


Figure 6. V<sub>GE</sub> vs. Saturation Voltage

## TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)



## TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

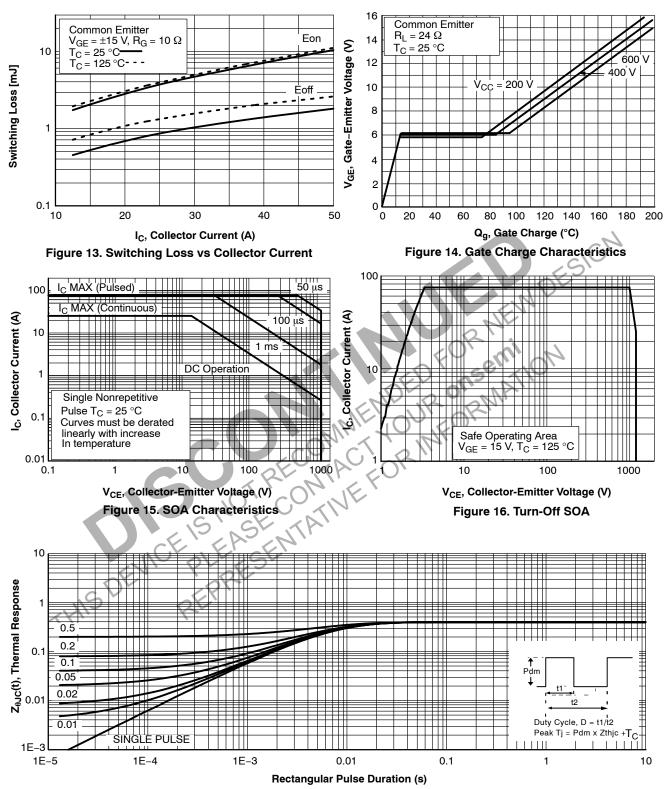
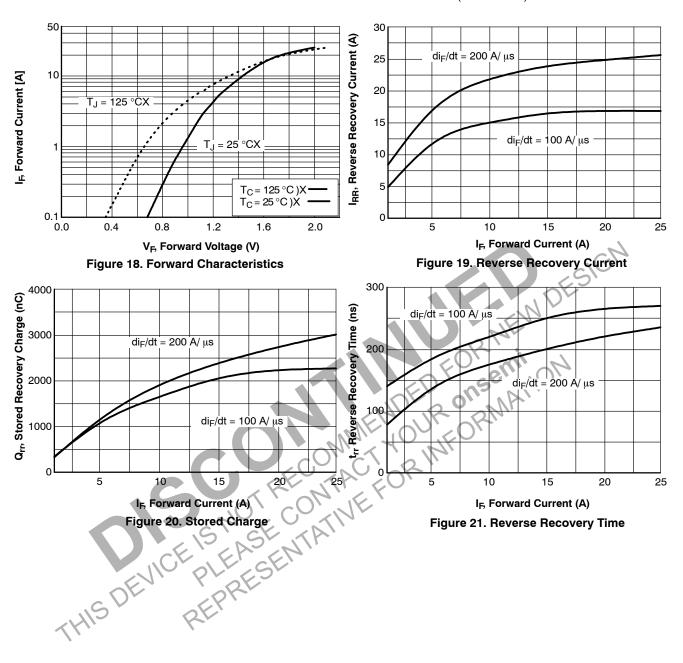


Figure 17. Transient Thermal Impedance of IGBT

## TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)



#### **REVISION HISTORY**

Revision	Description of Changes	Date	
5	Data Sheet Discontinued.	11/11/2025	

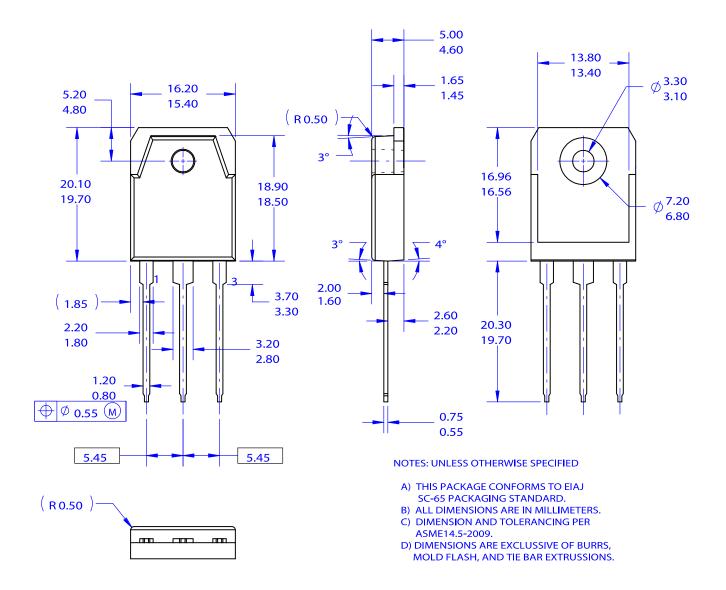
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.





## TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

**DATE 31 OCT 2016** 



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